



1 Feb  
\$2022  
PATENT  
8013-1147

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Hirokazu HONDA

Conf. 7187

Application No. 09/678,609

Group 2822

Filed October 4, 2000

Examiner David E. Graybill

MULTILAYER INTERCONNECTION BOARD, SEMICONDUCTOR  
DEVICE HAVING THE SAME, AND METHOD OF FORMING THE  
SAME AS WELL AS METHOD OF MOUNTING THE SEMICONDUCTOR  
CHIP ON THE INTERCONNECTION BOARD

PETITION FOR EXTENSION OF TIME

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 17, 2005

Sir:

The undersigned hereby petitions for an extension of  
time to respond to the Official Action of November 12, 2004  
for

two months to March 12, 2005.

Please charge the extension fee of \$450 to Deposit  
Account No. 25-0120. If this fee is insufficient, the Patent  
Office is hereby authorized to charge any additional extension  
fee to Deposit Account No. 25-0120. A duplicate copy of this  
sheet is enclosed.

A responsive paper is filed herewith.

Respectfully submitted,

YOUNG & THOMPSON

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TWP/lrs

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